

Green

- 0.36 inch digit height.
- Low current operation.
- Excellent character appearance.
- Easy mounting on P.C. boards or sockets.
- Categorized for luminous intensity.
- Mechanically rugged.
- Standard : gray face, white segment.
- RoHS compliant.

The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

The drawing includes three views of the package:

- Top View:** Shows the package footprint with dimensions: overall width 14.0 (0.551), distance from left edge to center line 9.14 (0.36), distance from center line to right edge 0.8 (0.031), and pin pitch 2.54 (0.1). Pin 1 is located at the top right. A 5° lead angle is specified for the pins.
- Side View:** Shows the package height and pin height. The total height is 8.5 (0.335) and the pin height is 4 (0.157) ± 0.5.
- Recommended PCB Layout:** Shows the pin connections with dimensions: overall width 5.08 (0.2), distance from left edge to center line 1.21 (0.048) ± 0.3, and pin pitch 2.54 (0.1). The pin connections are labeled 10, 9, 8, 5, 4, 2, 3, and 7.

1. All dimensions are in millimeters (inches), Tolerance is $\pm 0.25(0.01)$ "unless otherwise noted.



Selection Guide

Part No.	Dice	Lens Type	Iv (ucd) [1] @ 10mA		Description
			Min.	Typ.	
SA36-11CGKWA	Green (AlGaInP)	White Diffused	3600	11000	Common Anode, Rt. Hand Decimal.
			*1400	*3700	

Note:

1. Luminous intensity/ luminous Flux: +/-15%.

* Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λ_{peak}	Peak Wavelength	Green	574		nm	I _F =20mA
λ_D [1]	Dominant Wavelength	Green	570		nm	I _F =20mA
$\Delta\lambda_{1/2}$	Spectral Line Half-width	Green	20		nm	I _F =20mA
C	Capacitance	Green	15		pF	V _F =0V;f=1MHz
V _F [2]	Forward Voltage	Green	2.1	2.5	V	I _F =20mA
I _R	Reverse Current	Green		10	uA	V _R =5V

Notes:

1. Wavelength: +/-1nm.

2. Forward Voltage: +/-0.1V.

3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

Parameter	Green	Units
Power dissipation	75	mW
DC Forward Current	30	mA
Peak Forward Current [1]	150	mA
Reverse Voltage	5	V
Operating / Storage Temperature	-40°C To +85°C	
Lead Solder Temperature[2]	260°C For 3-5 Seconds	

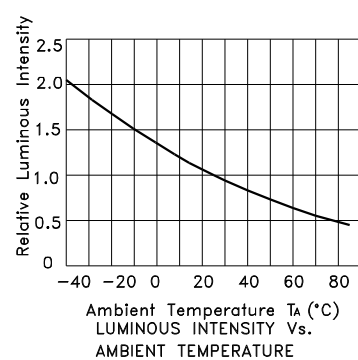
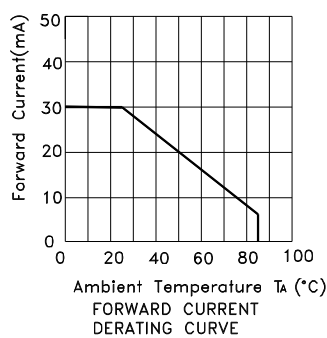
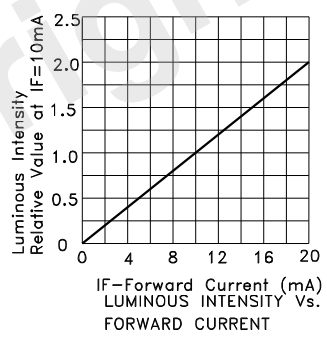
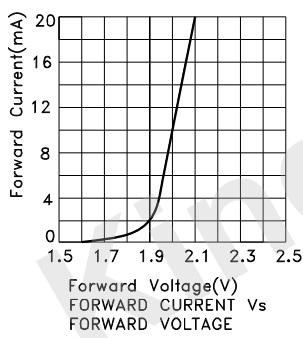
Notes:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

2. 2mm below package base.

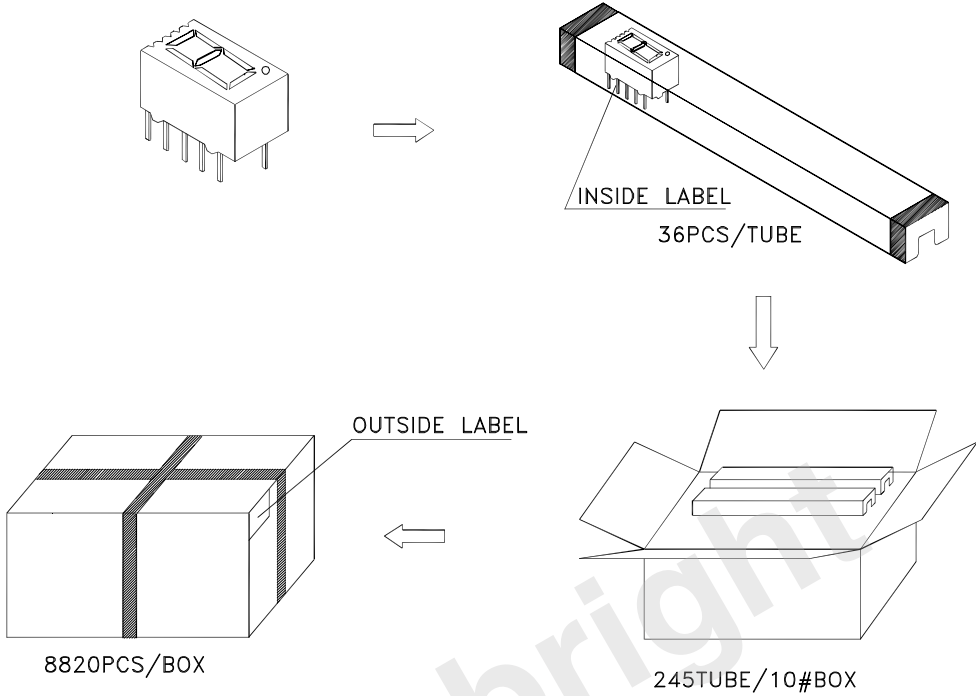


Green SA36-11CGKWA

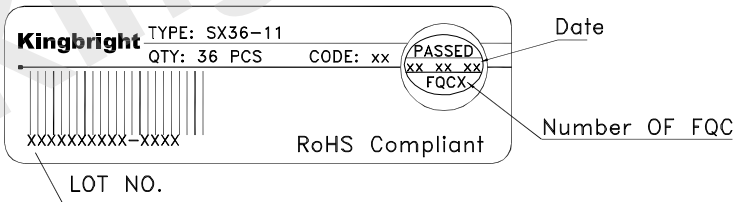


PACKING & LABEL SPECIFICATIONS

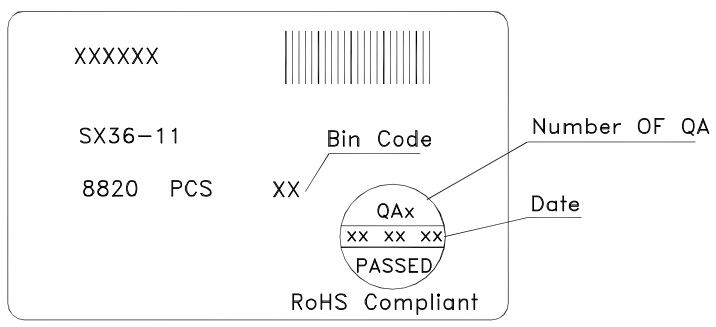
SA36-11CGKWA



Inside Label On IC-tube



Outside Label On Box

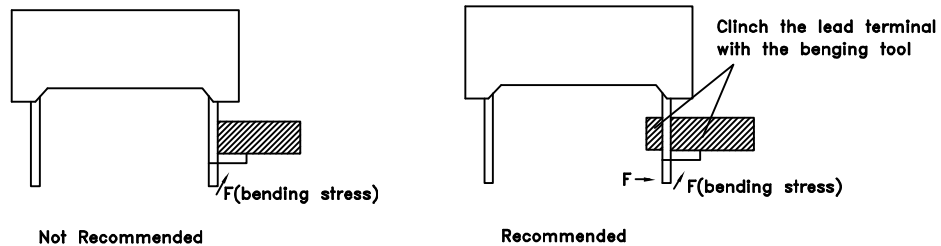


THROUGH HOLE DISPLAY MOUNTING METHOD

Lead Forming

Do not bend the component leads by hand without proper tools.

The leads should be bent by clinching the upper part of the lead firmly such that the bending force is not exerted on the plastic body.

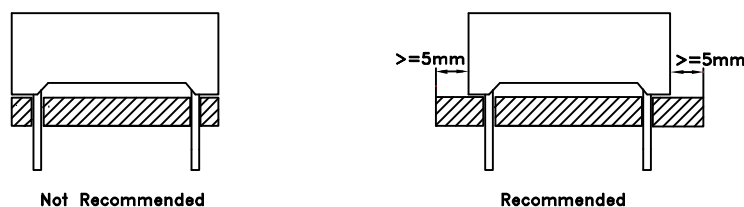


Installation

1. The installation process should not apply stress to the lead terminals.
2. When inserting for assembly, ensure the terminal pitch matches the substrate board's hole pitch to prevent spreading or pinching the lead terminals.

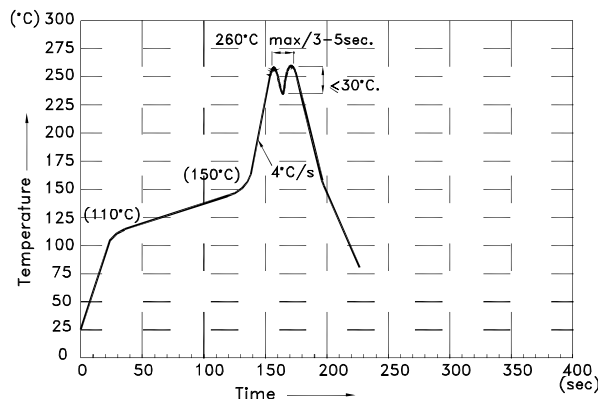


3. The component shall be placed at least 5mm from edge of PCB to avoid damage caused excessive heat during wave soldering.



DISPLAY SOLDERING CONDITIONS

Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

1. Recommend the wave temperature 245°C~260°C. The maximum soldering temperature should be less than 260°C.
2. Do not apply stress on epoxy resins when temperature is over 85°C.
3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
4. During wave soldering, the PCB top-surface temperature should be kept below 105°C.
5. No more than once.

Soldering General Notes:

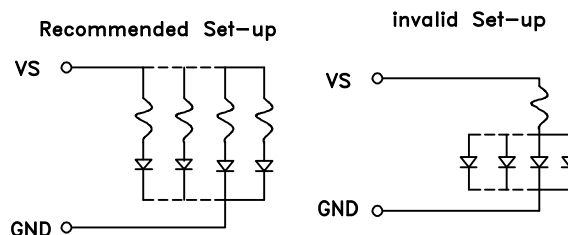
1. Through-hole displays are incompatible with reflow soldering.
2. If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with Kingbright for compatibility.

CLEANING

1. Mild "no-clean" fluxes are recommended for use in soldering.
2. If cleaning is required, Kingbright recommends to wash components with water only. Do not use harsh organic solvents for cleaning, because they may damage the plastic parts. And the devices should not be washed for more than one minute.

CIRCUIT DESIGN NOTES

1. Protective current-limiting resistors may be necessary to operate the Displays.
2. LEDs mounted in parallel should each be placed in series with its own current-limiting resistor.



Detailed application notes are listed on our website.

http://www.kingbright.com/application_notes